

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YOUNG BO SHIM	05/02/2014
YOUNG DO KWON	05/02/2014
BYUNG JUNE CHOI	05/02/2014
YONG JAE KIM	05/02/2014
KYUNG SHIK ROH	05/02/2014
MIN HYUNG LEE	05/02/2014
RECEIVING PARTY DATA	
Name:	SAMSUNG ELECTRONICS CO., LTD.
Street Address:	129, SAMSUNG-RO, YEONGTONG-GU, SUWON-SI, GYEONGGI-DO 443-742
City:	SUWON-SI
State/Country:	KOREA, REPUBLIC OF
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	14270880
CORRESPONDENCE DATA	
Fax Number:	(202)315-3758
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>	
Phone:	202-429-0020
Email:	pto@nsiplaw.com
Correspondent Name:	NSIP LAW
Address Line 1:	P.O. BOX 65745
Address Line 4:	WASHINGTON, DISTRICT OF COLUMBIA 20035
ATTORNEY DOCKET NUMBER:	012058.0006
NAME OF SUBMITTER:	RANDALL S. SVIHLA
SIGNATURE:	/Randall S. Svihla/
DATE SIGNED:	05/06/2014
Total Attachments: 3	
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COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

DECLARATION

As a below-named inventor, I hereby declare that this declaration is directed to the application attached hereto, or to United States Application Number or PCT International Application Number _____ filed on _____ (if applicable), entitled:

WIRE CONNECTION APPARATUS

The above-identified application was made or authorized to be made by me.

I believe I am the original inventor or an original joint inventor of a claimed invention in the above-identified application.

I hereby acknowledge that any willful false statement made in this declaration is punishable under 18 USC 1001 by fine or imprisonment of not more than five (5) years, or both.

I have reviewed and understand the contents of the above-identified application, including the claims.

I am aware of the duty to disclose to the United States Patent and Trademark Office all information known to me to be material to patentability as defined in 37 CFR 1.56, including for continuation-in-part applications, material information that became available between the filing date of the prior application and the national or PCT international filing date of the continuation-in-part application.

ASSIGNMENT

For valuable consideration, I, as a below-named assignor, hereby assign to:

Samsung Electronics Co., Ltd.
129, Samsung-ro, Yeongtong-gu
Suwon-si, Gyeonggi-do 443-742
Republic of Korea

and its successors and assigns (collectively hereinafter called "the Assignee"), the entire right, title, and interest throughout the world in the inventions and improvements that are the subject of the application identified in the above declaration, which is United States Application Number or PCT International Application Number 14/270,880 filed on May 6, 2014.

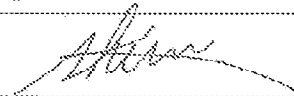
I authorize and request the attorneys appointed in the above-identified application to hereafter complete this Assignment by inserting above the application number and the filing date of the above-identified application when known, and to correct any typographical errors that may be discovered in this Assignment.

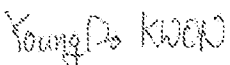
This Assignment includes the above-identified application, any and all United States and foreign patents, utility models, and design registrations granted for any of the inventions and improvements that are the subject of the above-identified application, and the right to claim priority based on the filing date of the above-identified application under the International Convention for the Protection of Industrial Property, the Patent Cooperation Treaty, the European Patent Convention, and all other treaties of like purposes; and I authorize the Assignee to apply in all countries in my name or in its own name for patents, utility models, design registrations, like rights of exclusion, and inventors' certificates for any of the inventions and improvements that are the subject of the above-identified application; and I agree for myself and my heirs, legal representatives, and assigns without further

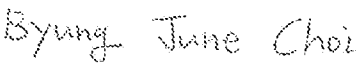
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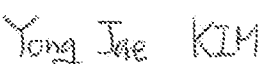
compensation to perform such lawful acts and to sign such further applications, Assignments, preliminary statements, and other lawful documents as the Assignee may reasonably request to effectuate fully this Assignment.

In witness whereof, I, as a below-named inventor and assignor, intending to be legally bound, have hereunto affixed my signature on the date indicated below next to my signature.

Inventor's Legal Name	Young Bo SHIM		
Inventor's Signature		Date	May 2, 2014
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	#10-402, Miseong Apt., Bulgwang-1-dong, Eunpyeong-gu, Seoul, Republic of Korea		

Inventor's Legal Name	Young Do KWON		
Inventor's Signature		Date	May 2, 2014
Residence (City, Country)	Yongin-si, Republic of Korea		
Mailing Address	#707-2503, Gyerong-rishivil, Gugaj-ri, Giheung-eup, Yongin-si, Gyeonggi-do, Republic of Korea		

Inventor's Legal Name	Byung June CHOI		
Inventor's Signature		Date	5. 2. 2014
Residence (City, Country)	Gunpo-si, Republic of Korea		
Mailing Address	#107-2601, E-pyeonghansasang-2nd Apt., Sanbon-2dong, Gunpo-si, Gyeonggi-do, Republic of Korea		

Inventor's Legal Name	Yong Jae KIM		
Inventor's Signature		Date	May/2/2014
Residence (City, Country)	Seoul, Republic of Korea		
Mailing Address	#101-702, WoojeongEshar Apt., Banpo-dong, Seocho-gu, Seoul, Republic of Korea		

COMBINED DECLARATION AND ASSIGNMENT UNDER 37 CFR 1.63(e)

Inventor's Legal Name	Kyung Shik ROH		
Inventor's Signature	<i>Kyung Shik Roh</i>	Date	5. 2. 2014
Residence (City, Country)	Seongnam-si, Republic of Korea		
Mailing Address	#114-901, Sibeomdanji-hansin Apt., Seohyeon-dong, Bundang-gu, Seongnam-si, Gyeonggi-do, Republic of Korea		

Inventor's Legal Name	Min Hyung LEE		
Inventor's Signature	<i>Minhyung Lee</i>	Date	5/2/2014
Residence (City, Country)	Anyang-si, Republic of Korea		
Mailing Address	#204-604, LG-village, Seoksu-dong, Manan-gu, Anyang-si, Gyeonggi-do, Republic of Korea		